

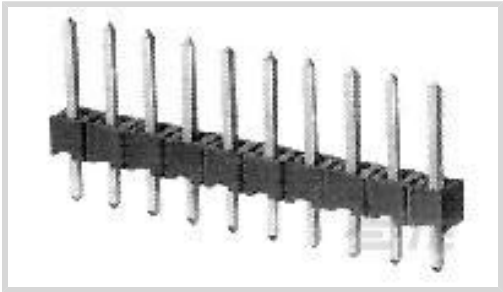
TE Internal #: 828083-9

AMPMODU Headers, PCB Mount Header, Vertical, Board-to-Board, 9 Position, 2.54mm [.1in] Centerline, Breakaway, Tin, Printed Circuit Board, Signal

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Connectors > PCB Connectors > Board-to-Board Connectors > Board-to-Board Headers & Receptacles



PCB Connector Assembly Type: **PCB Mount Header**

PCB Mount Orientation: **Vertical**

Connector System: **Board-to-Board**

Number of Positions: **9**

Centerline (Pitch): **2.54 mm [ .1 in ]**

Features

Product Type Features

|                                   |                       |
|-----------------------------------|-----------------------|
| PCB Connector Assembly Type       | PCB Mount Header      |
| Connector System                  | Board-to-Board        |
| Header Type                       | Breakaway             |
| Sealable                          | No                    |
| Connector & Contact Terminates To | Printed Circuit Board |

Configuration Features

|                                  |              |
|----------------------------------|--------------|
| Number of Rows                   | 1            |
| Connector Contact Load Condition | Fully Loaded |
| PCB Mount Orientation            | Vertical     |
| Number of Positions              | 9            |
| Board-to-Board Configuration     | Parallel     |

Body Features

|                   |                  |
|-------------------|------------------|
| Connector Profile | Standard         |
| Post Size         | .63 mm[.0248 in] |

Contact Features

|   |        |
|---|--------|
| PCB Contact Termination Area Plating Material Thickness | 2 μm   |
| Contact Shape & Form                                    | Square |
| Contact Underplating Material                           | Nickel |



|                                      |      |
|--------------------------------------|------|
| Contact Base Material                | CuSn |
| Contact Mating Area Plating Material | Tin  |
| Contact Type                         | Pin  |

Termination Features

|   |                       |
|---|-----------------------|
| Termination Post & Tail Length              | 3.3 mm[.13 in]        |
| Termination Method to Printed Circuit Board | Through Hole - Solder |

Mechanical Attachment

|                         |             |
|-------------------------|-------------|
| Mating Alignment        | Without     |
| PCB Mount Retention     | Without     |
| PCB Mount Alignment     | Without     |
| Connector Mounting Type | Board Mount |

Housing Features

|                    |                |
|--------------------|----------------|
| Centerline (Pitch) | 2.54 mm[.1 in] |
| Housing Color      | Green          |
| Housing Material   | PBTP GV        |

Usage Conditions

|                             |              |
|-----------------------------|--------------|
| Housing Temperature Rating  | Standard     |
| Operating Temperature Range | -65 – 105 °C |

Operation/Application

|                        |                |
|------------------------|----------------|
| Solder Process Feature | Board Standoff |
| Circuit Application    | Signal         |

Industry Standards

|                        |          |
|------------------------|----------|
| UL Flammability Rating | UL 94V-0 |
|------------------------|----------|

Other

|                            |      |
|----------------------------|------|
| Position Locations Omitted | None |
|----------------------------|------|

Product Compliance

For compliance documentation, visit the product page on TE.com>

|   |   |
|---|---|
| EU RoHS Directive 2011/65/EU                  | Compliant                               |
| EU ELV Directive 2000/53/EC                   | Compliant                               |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold |
| EU REACH Regulation (EC) No. 1907/2006        |   |



Current ECHA Candidate List: JAN 2020 (205)  
Candidate List Declared Against: JAN 2020 (205)  
Does not contain REACH SVHC

|  |  |
|--|--|
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JAN 2020 (205)<br>Candidate List Declared Against: JAN 2020 (205) |
|--|--|

|                 |   |
|-----------------|---|
| Halogen Content | Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free |
|-----------------|---|

|                           |                              |
|---------------------------|------------------------------|
| Solder Process Capability | Wave solder capable to 265°C |
|---------------------------|------------------------------|

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulations, TE’s information on SVHC in articles for this part number is still based on the European Chemical Agency (ECHA) ‘Guidance on requirements for substances in articles’(Version: 2, April 2011), applying the 0.1% weight on weight concentration threshold at the finished product level. TE is aware of the European Court of Justice ruling of September 10th, 2015 also known as O5A (Once An Article Always An Article) stating that, in case of ‘complex object’, the threshold for a SVHC must be applied to both the product as a whole and simultaneously to each of the articles forming part of its composition. TE has evaluated this ruling based on the new ECHA “Guidance on requirements for substances in articles” (June 2017, version 4.0) and will be updating its statements accordingly.

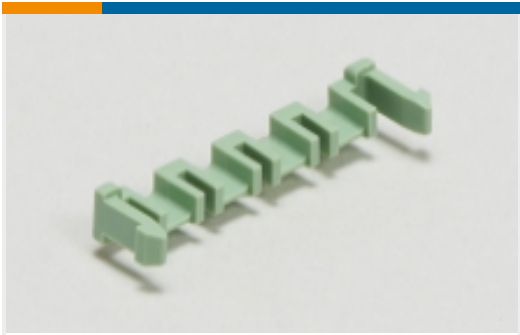
Also in the Series | AMPMODU Headers

Automotive, Truck, Bus, & Off-Road Headers(10)

Board-to-Board Headers & Receptacles(5302)

PCB Connector Mounting(1)

PCB Connector Shrouds(1)



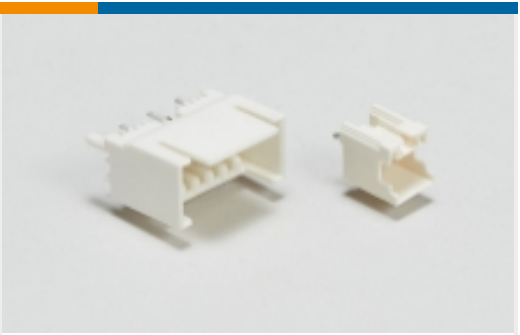
PCB Latches, Locks & Retainers(2)



Wire-to-Board Connector Assemblies & Housings(3)



Wire-to-Board Connector Contacts(45)



Wire-to-Board Headers & Receptacles (76)

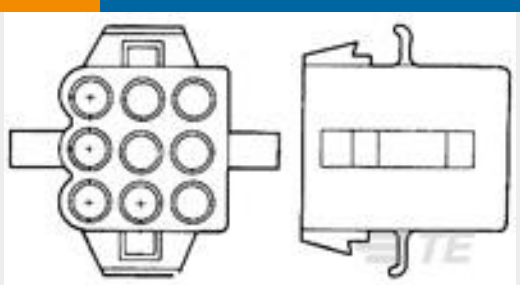
Customers Also Bought



TE Model / Part #2177786-5  
7POS, MIXED,HSG, IEC62196-2 TYPE 2,Left



TE Model / Part #CV36666001  
QSZH-125-NR4-65MM



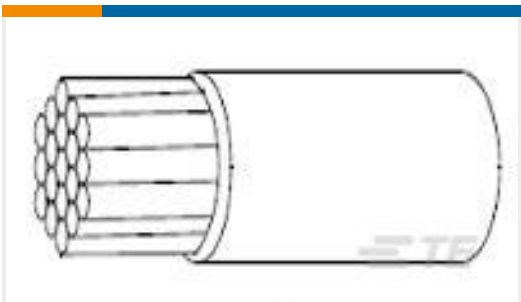
TE Model / Part #1-480672-4  
09P .140 MNL PLUG YEL



TE Model / Part #1823734-2  
PIN DIA 6.35,25SQMM; CRIMP



TE Model / Part #2151556-1  
OC-AT-S-FM-080F160O-001-0220



TE Model / Part #CT57013001  
55A0111-14-09

Documents

Product Drawings

9P MOD 2 STIFTLEI

English

Datasheets & Catalog Pages

AMPMODU Interconnetion System

AMPMODU Interconnetion System

English